

PRODUCT SPECIFICATION



Part No. : JH-2835WB12P18-T10A-Q4-467.5 High Power LED

Catalog	
1.Product Features	P2
2.Dimensions	P2
3.Absolute Maximum Rating	P3
4.Optical Character	P3
5.Optical Character Curves	P4
6.Spectrum Curves	P5
7.Viewing Angle Curves	P5
8.Tape&Reel Packing	P6
9.Soldering Advice	P7
10.Cautions	P8

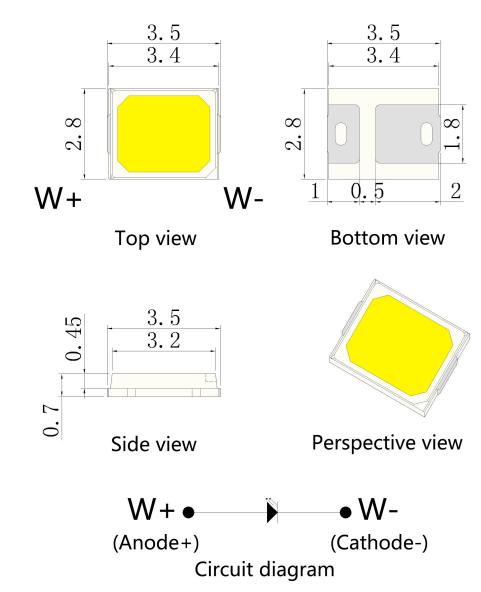


1.Product Features

- High Brightness White LED
 Round Package
- Viewing Angle 120 Degree

2.Dimensions

- Chip Material: InGaN AlGaInP
- RoHS Compliant



Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerance is ±0.1mm unless otherwise noted.



3.Absolute Maximum Rating @ Ta=25° C

Parameter	Symbol	Maximum Rating	Unit
Continuous Forward Current	IF	300	mA
Peak Forward Current	IFp	400	mA
(1/10 Duty Cycle, 0.1ms Pulse Width)			
Reverse Voltage	VR	5	V
Power Dissipation	PD	1	W
Electrostatic Discharge	ESD	1000	V
Operating Temperature Range	TOPR	-25°C to +80°C	
Storage Temperature Range	TSTG	-35°C to +100°C	
Lead Soldering Temperature	TSOL	260°C	

4.光学特征 @ Ta=25°C /Optical Character @ Ta=25° C

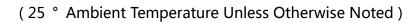
Parameter	Symbol	Color	Min.	Тур.	Max.	Unit	Test Condition
Forward Voltage	VF	W	2.8	2.9	3.0	V	I _F =150mA
Luminous Flux	Φ	W	40	45	50	LM	I _F =150mA
Color Temperature	Тс	W	3750	4000	4250	К	I _F =150mA
Color rendering index	Ra	W	90			/	I _F =150mA
Reverse Current	IR		0		1	μA	V _R =5V
Viewing Angle	201/2			120		deg	I _F =150mA
Recommend Forward Current	IF(rec)	W			150	mA	

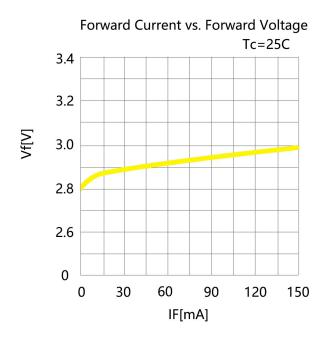
Notes:

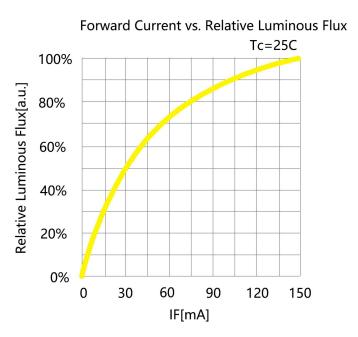
Measurement tolerance of forward voltage $\pm 0.1V$

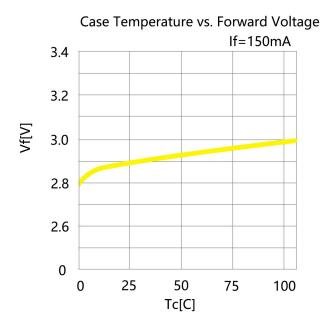


5. Optical Character Curves

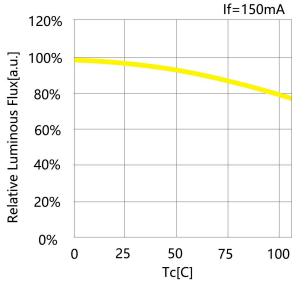






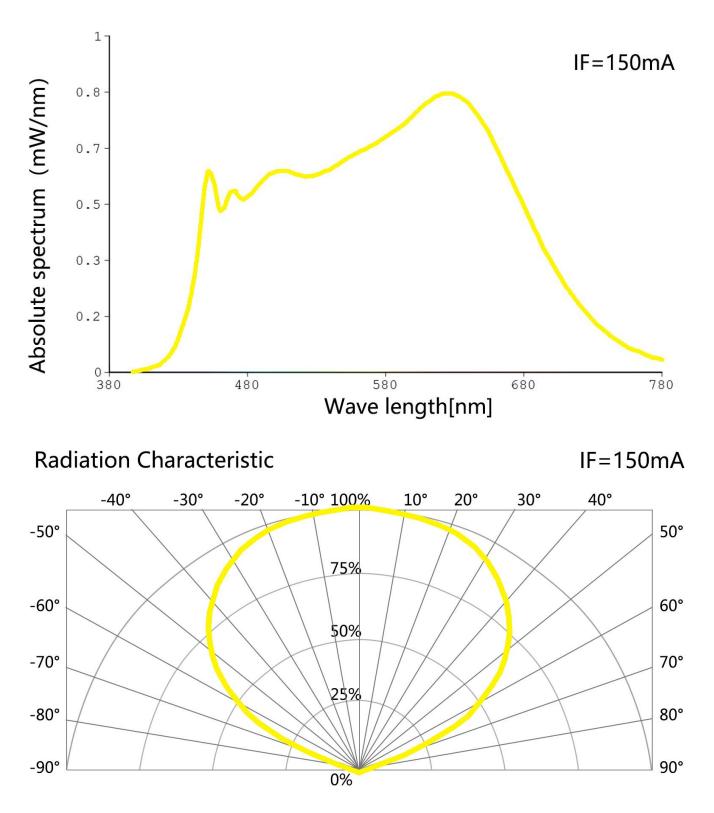


Case Temperature vs. Relative Luminous Flux





6. Spectrum Curves

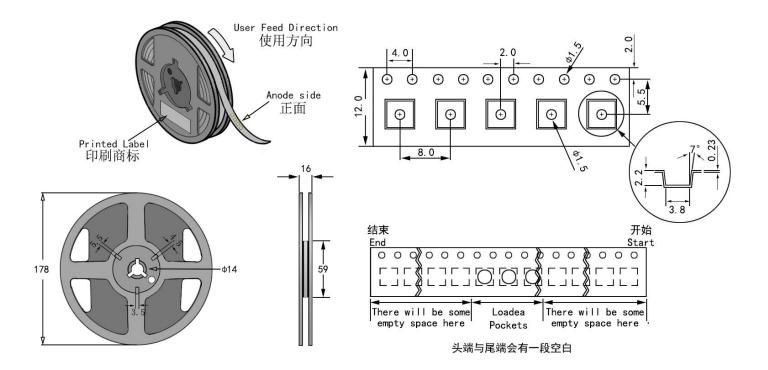


7. Viewing Angle Curves



8.Tape&Reel Packing

1. Recommend unpacked LED beads be welded within one day, if not, please vacuumize again and store in an environment of 20-35°C and 30-60% humidity. If can't vacuumize, please store LED beads in moisture proof box, control at 25°C±3°C, humidity 50-60%. If unpacked above 1week, bake at 60±5°C for 10-12 hours before weld.



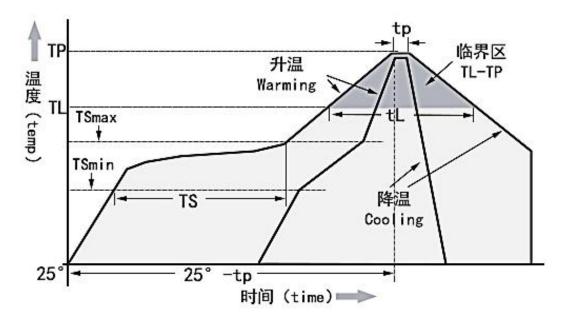
Notes:

- 1. QTY: 1000pcs/Reel
- 2. Tolerance ±0.2mm.
- 3. Package: P/N



9.Soldering Advice

1. When soldering,don't touch the LED appearance gel during,this bad operation will destroy the LED.Moding LED usually use reflow soldering, please refer to the following reflow temperature curve , and recommend the user follow the soldering temperature curve of the solder paste.



Temperature Curve Character	Lead-free solder			
Average heating rate(TSmin to Tp)	最高 3℃/秒			
	Top 3 ℃ / s			
Preheating: Minimum temperature (TSmin)	90°C			
Preheating: Maximum temperature (TSmax)	200°C			
Preheating: Time (TSmin to TSmax)	60-180 s			
Duration above temperature: Temperature TL	240°C			
Duration above temperature: Time tL	60-150 s			
Peak/classification temperature (Tp)	260°C			
Time within 5°C of actual peak temperature (tp)	20-40 s			
	最高 6℃/秒			
Cooling speed	The highest 6 $^\circ C$ / s			
Time to me do a shi tanun antana da 2500	最多8分钟			
Time to reach peak temperature at 25°C	8 minutes Max			



10.Cautions

1. Electrostatic Treatment

Do a full range of anti-static measures (such as: anti-static ring, anti-static clothes, machine, equipment grounding wire, etc.)

2. Heat Dissipation

- A、 It is recommend to configure reasonable heat dissipation device for the product.
- B. The best working temperature range of the product is 40-60°. It is recommended to control

the working temperature of the product within a reasonable range.

存格 Substrate Ger paste Defense Silicone grease Mah:Lage ABIdor The temperature of heat sink shall not exceed 60 ℃

3. Installation Conditions

A. Do not exert any pressure on the LED area during the use of the led beads. such as below:

